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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)/Execution Date(s):
 BILY WANG
 SUNG-YI HSIAO
 JACK CHEN

Execution Date(s) 1/9/2009; 1/9/2009; 1/9/2009

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
 Name: HARVATEK CORPORATION

Street Address: NO. 18, LANE 522, SEC. 5,
JHONGHUA RD.

City: HSINCHU CITY

State: _____

Country: TAIWAN, R.O.C. Zip: _____

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

Assignment Merger

Security Agreement Change of Name

Government Interest Assignment

Executive Order 9424, Confirmatory License

Other _____

4. Application or patent number(s): This document is being filed together with a new application.

A. Patent Application No.(s)
12/318,876

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Morton J. Rosenberg, Esq.

Internal Address: Rosenberg, Klein & Lee

Street Address: 3458 Ellicott Center Drive,
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6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

Authorized to be charged by credit card

Authorized to be charged to deposit account

Enclosed


None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
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Authorized User Name _____

9. Signature  1/23/2009
 Signature Date

Morton J. Rosenberg
 Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 2

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PATENT
 REEL: 022158 FRAME: 0550

CH \$40.00 182011 12318876

ASSIGNMENT DEED

This Assignment agreement is applicable to an invention entitled (invention Title) WAFER LEVEL VERTICAL DIODE PACKAGE STRUCTURE AND METHOD FOR MAKING THE SAME

The PATENT RIGHTS referred to in this agreement are:

(Check one) a Patent Application for this invention, executed by the ASSIGNOR(s) concurrently with this Assignment
 U.S. Patent Application Serial No. 12/318,876, filed 1/12/2009
 U.S. Patent No. _____, issued _____

The PATENT RIGHTS assigned under this agreement are:

(Check one) U.S. Patent rights only
 worldwide Patent rights. In this case, the Assignee shall have the right to claim the benefit of the filing date of any U.S. Patent Application identified above.

The ASSIGNOR(s) referred to in this agreement is (or are):

(Full name of sole or first inventor) BILY WANG (FAMILY NAME: WANG)
(Address) NO. 18, LANE 522, SEC. 5, JHONGHUA RD., HSINCHU CITY, TAIWAN, R.O.C.

(Full name of second joint inventor, if any) SUNG-YI HSIAO (FAMILY NAME: HSIAO)
(Address) NO. 209, 13TH NEIGHBORHOOD, GUANDONG GONGGUAN SHIANG, MIAOLI COUNTY 36344, TAIWAN, R.O.C.

(Full name of third joint inventor, if any) JACK CHEN (FAMILY NAME: CHEN)
(Address) NO. 14, HEPING RD., TOUFEN TOWNSHIP, MIAOLI COUNTY 351, TAIWAN, R.O.C.

(Full name of fourth joint inventor, if any) _____
(Address) _____

The First ASSIGNEE referred to in this agreement is:

(Name of Assignee) HARVATEK CORPORATION
(Address of Assignee) NO. 18, LANE 522, SEC. 5, JHONGHUA RD., HSINCHU CITY, TAIWAN, R.O.C.

The Second ASSIGNEE referred to in this agreement is:

(Name of Assignee) _____
(Address of Assignee) _____

The First ASSIGNEE is:

(Check one) an individual
 a partnership
 a Corporation of TAIWAN, R.O.C.
(State of Country)

The Second ASSIGNEE is:

(Check one) an individual
 a partnership
 a Corporation of _____
(State of Country)

The ASSIGNOR(S), in consideration of \$ 1.00 paid by each ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, have and do hereby assign the following to each ASSIGNEE; their successors and assigns:

the full and exclusive right to the invention;
an equal interest in and to the entire right, title and interest in and to the PATENT RIGHTS; and
the right to claim priority under 35 U.S.C. 119, based on any earlier foreign applications for this invention.

As to all U.S. Patent Applications assigned under this Agreement, the ASSIGNOR(s) hereby authorize(s) and requests the Commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE(s) as the ASSIGNEE(s) of an equal interest in the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE(s), their successors and assigns.

Further, the ASSIGNOR(s) agree(s) to communicate to said ASSIGNEE(s), or their representatives, any facts known to the ASSIGNOR(s) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE(s), make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE(s), their successors and assigns, to obtain and enforce proper protection for said invention.

BILY WANG (FAMILY NAME: WANG)

Bily Wang
(Signature of sole or first inventor)

JANUARY 09, 2009
(Date)

SUNG-YI HSIAO (FAMILY NAME: HSIAO)

Sung-Yi Hsiao
(Signature of second inventor, if any)

JANUARY 09, 2009
(Date)

JACK CHEN (FAMILY NAME: CHEN)

Jack Chen
(Signature of third inventor, if any)

JANUARY 09, 2009
(Date)

PATENT